



20V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	RDS(ON) max	Package	I _{D max} T _A = +25°C
-20V	$60m\Omega @ V_{GS} = -4.5V$		-4.0A
-200	$90m\Omega @ V_{GS} = -2.5V$	SOT-23	

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(on)}$) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Features

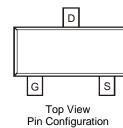
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative.

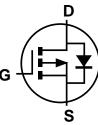
https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 3
- Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42 Lead-Frame).
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)







Equivalent Circuit

Ordering Information (Note 4)

Top View

Part Number	Case	Packaging
DMP2065U-7	SOT23	3000/Tape & Reel
DMP2065U-13	SOT23	10,000/Tape & Reel

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information

Notes:

Date Code Key			65U	M×	5U = Product Type Markin YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = Septen										
Year	202	0	2021		2022	20	23	2024		2025	2	026			
Code	Н		I J		J K		J		J		L		М		Ν
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec			
Code	1	2	3	4	5	6	7	8	9	0	N	D			



Maximum Ratings (@ T_A = +25°C unless otherwise specified.)

Characteris	tic	Symbol	Value	Units
Drain-Source Voltage		V _{DSS}	-20	V
Gate-Source Voltage		V _{GSS}	±12	V
Drain Current (Note 6) V _{GS} = -4.5V	Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$	ID	-4.0 -3.0	А
Pulsed Drain Current (Pulse width ≤10µS	, Duty Cycle ≤1%)	I _{DM}	-15	А

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	138	°C/W
Total Power Dissipation (Note 6)		PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	83	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@ T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						·
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	I _{DSS}	_		-1.0	μA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_		±50	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-0.5		-0.9	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
			41	60		$V_{GS} = -4.5V, I_D = -4.2A$
Static Drain-Source On-Resistance	R _{DS (ON)}	—	53	90	mΩ	$V_{GS} = -2.5V, I_D = -3.4A$
			72	113		V _{GS} = -1.8V, I _D = -2.0A
Diode Forward Voltage	V _{SD}	_	-0.7	-1.1	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		808		pF	
Output Capacitance		_	85		pF	−V _{DS} = -15V, V _{GS} = 0V −f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	77	—	pF	1 = 1.00012
Gate Resistance	R _G	_	15.2	_	Ω	$V_{GS} = 0V$, $V_{DS} = 0V$, $f = 1.0MHz$
Total Gate Charge	Qg	_	10.2	_	nC	
Gate-Source Charge	Q _{gs}	_	1.3	_	nC	V _{GS} = -4.5V, V _{DS} = -4V, I _D = -3.5A
Gate-Drain Charge	Q _{gd}	_	2.2	_	nC	
Turn-On Delay Time	t _{D(on)}	_	10.8		ns	
Turn-On Rise Time	tr	_	13.7		ns	$V_{DS} = -4V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(off)}		79.3		ns	$R_L = 4\Omega, R_G = 6\Omega, I_D = -1A$
Turn-Off Fall Time	t _f	_	34.7		ns	7

Notes:

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1in. square copper plate.

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.



150°C

3

7

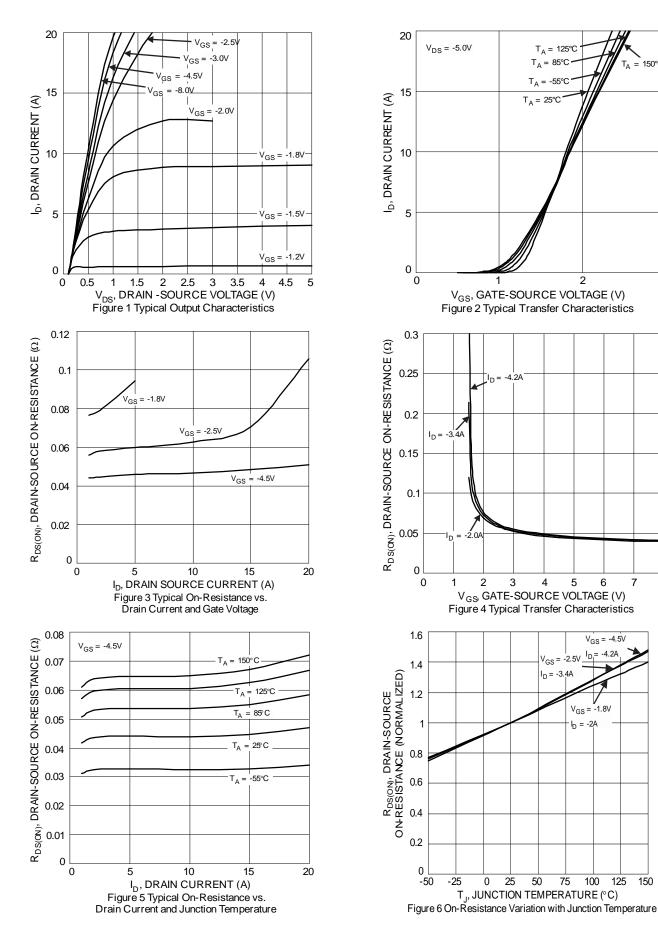
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 $V_{GS} = -4.5V$

I_D:

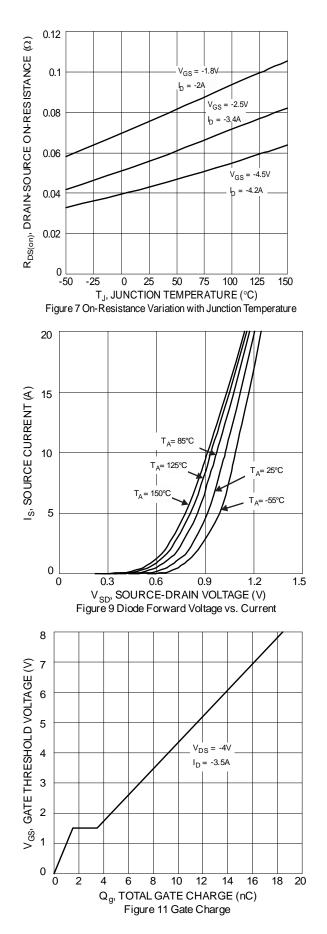
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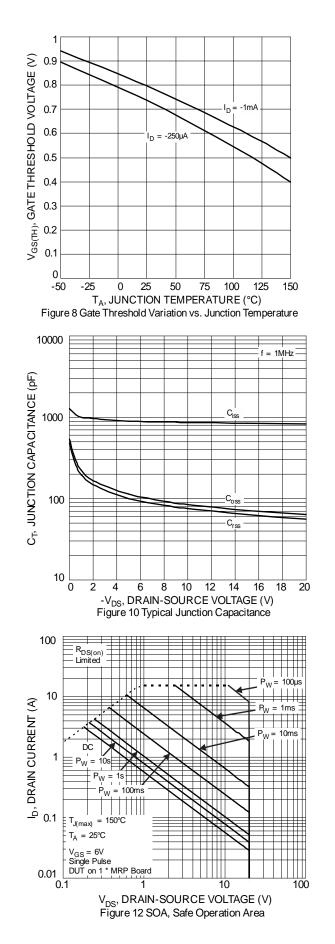
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150



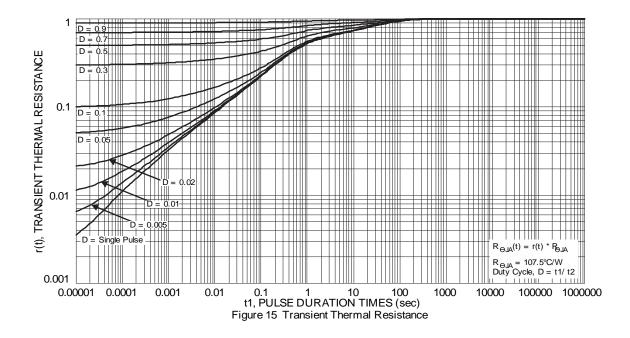




DMP2065U Document number: DS43051 Rev. 2 - 2 4 of 7 Downloaded From Oneyac.com



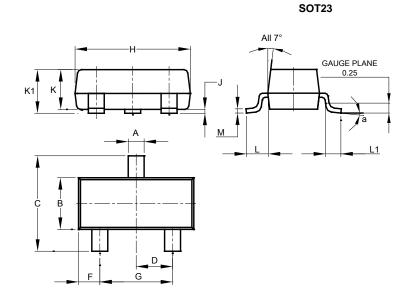






Package Outline Dimensions

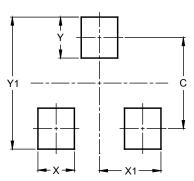
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT23							
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
М	0.085	0.150	0.110					
а	0°	8°						
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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